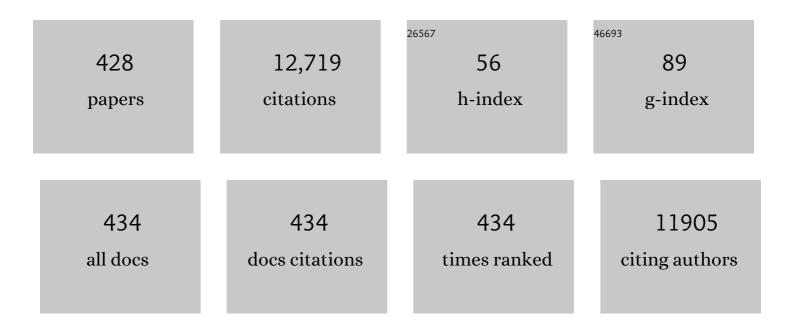
Christophe Detavernier

List of Publications by Year in descending order

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#	Article	IF	CITATIONS
1	Towards implementation of a nickel silicide process for CMOS technologies. Microelectronic Engineering, 2003, 70, 144-157.	1.1	387
2	Super-dry reforming of methane intensifies CO ₂ utilization via Le Chatelier's principle. Science, 2016, 354, 449-452.	6.0	348
3	Tailoring nanoporous materials by atomic layer deposition. Chemical Society Reviews, 2011, 40, 5242.	18.7	338
4	Three-Dimensional Observation of the Conductive Filament in Nanoscaled Resistive Memory Devices. Nano Letters, 2014, 14, 2401-2406.	4.5	290
5	Barrier height inhomogeneities of epitaxial CoSi2 Schottky contacts on n-Si (100) and (111). Solid-State Electronics, 2000, 44, 663-671.	0.8	225
6	High-k dielectrics for future generation memory devices (Invited Paper). Microelectronic Engineering, 2009, 86, 1789-1795.	1.1	218
7	Atomic layer deposition of TiO2 from tetrakis-dimethyl-amido titanium or Ti isopropoxide precursors and H2O. Journal of Applied Physics, 2007, 102, .	1.1	214
8	Thin film reaction of transition metals with germanium. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2006, 24, 474-485.	0.9	208
9	An off-normal fibre-like texture in thin films on single-crystal substrates. Nature, 2003, 426, 641-645.	13.7	181
10	Atomic layer deposition of titanium nitride from TDMAT precursor. Microelectronic Engineering, 2009, 86, 72-77.	1.1	149
11	CeO ₂ -Modified Fe ₂ O ₃ for CO ₂ Utilization via Chemical Looping. Industrial & Engineering Chemistry Research, 2013, 52, 8416-8426.	1.8	149
12	In-situ X-ray Diffraction study of Metal Induced Crystallization of amorphous silicon. Thin Solid Films, 2008, 516, 4946-4952.	0.8	140
13	Germanium surface passivation and atomic layer deposition of high- <i>k</i> dielectrics—a tutorial review on Ge-based MOS capacitors. Semiconductor Science and Technology, 2012, 27, 074012.	1.0	138
14	Effects of additive elements on the phase formation and morphological stability of nickel monosilicide films. Microelectronic Engineering, 2006, 83, 2042-2054.	1.1	121
15	Plasma-enhanced chemical vapour deposition growth of Si nanowires with low melting point metal catalysts: an effective alternative to Au-mediated growth. Nanotechnology, 2007, 18, 505307.	1.3	120
16	Growth Kinetics and Crystallization Behavior of TiO[sub 2] Films Prepared by Plasma Enhanced Atomic Layer Deposition. Journal of the Electrochemical Society, 2008, 155, H688.	1.3	111
17	Catalyst-assisted chemical looping for CO2 conversion to CO. Applied Catalysis B: Environmental, 2015, 164, 184-191.	10.8	110
18	High-temperature degradation of NiSi films: Agglomeration versus NiSi2 nucleation. Journal of Applied Physics, 2005, 98, 033526.	1.1	106

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19	<i>In situ</i> x-ray diffraction study of metal induced crystallization of amorphous germanium. Journal of Applied Physics, 2009, 105, .	1.1	103
20	The coordinatively saturated vanadium MIL-47 as a low leaching heterogeneous catalyst in the oxidation of cyclohexene. Journal of Catalysis, 2012, 285, 196-207.	3.1	100
21	Delivering a Modifying Element to Metal Nanoparticles via Support: Pt–Ga Alloying during the Reduction of Pt/Mg(Al,Ga)O _{<i>x</i>} Catalysts and Its Effects on Propane Dehydrogenation. ACS Catalysis, 2014, 4, 1812-1824.	5.5	100
22	Independent tuning of size and coverage of supported Pt nanoparticles using atomic layer deposition. Nature Communications, 2017, 8, 1074.	5.8	95
23	Influence of Pt addition on the texture of NiSi on Si(001). Applied Physics Letters, 2004, 84, 3549-3551.	1.5	93
24	Modeling the Conformality of Atomic Layer Deposition: The Effect of Sticking Probability. Journal of the Electrochemical Society, 2009, 156, P63.	1.3	92
25	Conformality of Al[sub 2]O[sub 3] and AlN Deposited by Plasma-Enhanced Atomic Layer Deposition. Journal of the Electrochemical Society, 2010, 157, G111.	1.3	91
26	Low-Temperature Atomic Layer Deposition of Platinum Using (Methylcyclopentadienyl)trimethylplatinum and Ozone. Journal of Physical Chemistry C, 2013, 117, 20557-20561.	1.5	90
27	Influence of the Cu-Te composition and microstructure on the resistive switching of Cu-Te/Al2O3/Si cells. Applied Physics Letters, 2011, 99, .	1.5	89
28	Controlling the stability of a Fe–Ni reforming catalyst: Structural organization of the active components. Applied Catalysis B: Environmental, 2017, 209, 405-416.	10.8	89
29	Reactor concepts for atomic layer deposition on agitated particles: A review. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2014, 32, .	0.9	85
30	Ballistic electron emission microscopy study of barrier height inhomogeneities introduced in Au/n-Si Schottky contacts by a HF pretreatment. Journal of Applied Physics, 1998, 84, 3226-3231.	1.1	82
31	Influence of mixing entropy on the nucleation of CoSi2. Physical Review B, 2000, 62, 12045-12051.	1.1	78
32	Semiconductor-metal transition in thin VO2 films grown by ozone based atomic layer deposition. Applied Physics Letters, 2011, 98, .	1.5	78
33	Optimizations of Pulsed Plated p and nâ€ŧype Bi ₂ Te ₃ â€Based Ternary Compounds by Annealing in Different Ambient Atmospheres. Advanced Energy Materials, 2013, 3, 95-104.	10.2	77
34	Plasma enhanced atomic layer deposition of Ga ₂ O ₃ thin films. Journal of Materials Chemistry A, 2014, 2, 19232-19238.	5.2	77
35	A USB-controlled potentiostat/galvanostat for thin-film battery characterization. HardwareX, 2017, 2, 34-49.	1.1	76
36	Red Mn ⁴⁺ -Doped Fluoride Phosphors: Why Purity Matters. ACS Applied Materials & Interfaces, 2018, 10, 18845-18856.	4.0	74

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37	Phase formation and thermal stability of ultrathin nickel-silicides on Si(100). Applied Physics Letters, 2010, 96, .	1.5	73
38	Amorphous and Crystalline Vanadium Oxides as High-Energy and High-Power Cathodes for Three-Dimensional Thin-Film Lithium Ion Batteries. ACS Applied Materials & Interfaces, 2017, 9, 13121-13131.	4.0	73
39	Metalâ€Insulator Transition in ALD VO ₂ Ultrathin Films and Nanoparticles: Morphological Control. Advanced Functional Materials, 2015, 25, 679-686.	7.8	70
40	Selective and reversible ammonia gas detection with nanoporous film functionalized silicon photonic micro-ring resonator. Optics Express, 2012, 20, 11855.	1.7	69
41	Thermodynamics and kinetics of room-temperature microstructural evolution in copper films. Journal of Applied Physics, 2003, 94, 2874-2881.	1.1	67
42	Comparison of Thermal and Plasma-Enhanced ALD/CVD of Vanadium Pentoxide. Journal of the Electrochemical Society, 2009, 156, P122.	1.3	67
43	A BEEM study of the temperature dependence of the barrier height distribution in PtSi/n-Si Schottky diodes. Solid State Communications, 1999, 112, 611-615.	0.9	66
44	In Situ X-ray Fluorescence Measurements During Atomic Layer Deposition: Nucleation and Growth of TiO ₂ on Planar Substrates and in Nanoporous Films. Journal of Physical Chemistry C, 2011, 115, 6605-6610.	1.5	66
45	Fe-Containing Magnesium Aluminate Support for Stability and Carbon Control during Methane Reforming. ACS Catalysis, 2018, 8, 5983-5995.	5.5	66
46	Electrical characteristics of CoSi2/n-Si(100) Schottky barrier contacts formed by solid state reaction. Solid-State Electronics, 2000, 44, 1807-1818.	0.8	63
47	Microencapsulation of Moisture-Sensitive CaS:Eu[sup 2+] Particles with Aluminum Oxide. Journal of the Electrochemical Society, 2009, 156, J333.	1.3	63
48	Optimization of Electrodeposited pâ€Doped Sb ₂ Te ₃ Thermoelectric Films by Millisecond Potentiostatic Pulses. Advanced Energy Materials, 2012, 2, 345-352.	10.2	63
49	Partially fluorinated MIL-47 and Al-MIL-53 frameworks: influence of functionalization on sorption and breathing properties. Physical Chemistry Chemical Physics, 2013, 15, 3552.	1.3	63
50	Reaction of thin Ni films with Ge: Phase formation and texture. Journal of Applied Physics, 2006, 100, 034306.	1.1	62
51	Thermal expansion of the isostructural PtSi and NiSi: Negative expansion coefficient in NiSi and stress effects in thin films. Journal of Applied Physics, 2003, 93, 2510-2515.	1.1	61
52	Understanding the Dual Nature of the Filament Dissolution in Conductive Bridging Devices. Journal of Physical Chemistry Letters, 2015, 6, 1919-1924.	2.1	61
53	Plasmonic gold-embedded TiO2 thin films as photocatalytic self-cleaning coatings. Applied Catalysis B: Environmental, 2020, 267, 118654.	10.8	61
54	Tuning the Pore Size of Ink-Bottle Mesopores by Atomic Layer Deposition. Chemistry of Materials, 2012, 24, 1992-1994.	3.2	59

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55	Voltage-Controlled ON–OFF Ferromagnetism at Room Temperature in a Single Metal Oxide Film. ACS Nano, 2018, 12, 10291-10300.	7.3	57
56	Formation and morphological stability of NiSi in the presence of W, Ti, and Ta alloying elements. Journal of Applied Physics, 2007, 101, 044508.	1.1	56
57	Composition influence on the physical and electrical properties of SrxTi1â^'xOy-based metal-insulator-metal capacitors prepared by atomic layer deposition using TiN bottom electrodes. Journal of Applied Physics, 2009, 106, 094101.	1.1	56
58	Deactivation Study of Fe ₂ O ₃ –CeO ₂ during Redox Cycles for CO Production from CO ₂ . Industrial & Engineering Chemistry Research, 2016, 55, 5911-5922.	1.8	56
59	Air-stable short-wave infrared PbS colloidal quantum dot photoconductors passivated with Al2O3 atomic layer deposition. Applied Physics Letters, 2014, 105, .	1.5	55
60	In situ X-ray diffraction study of the controlled oxidation and reduction in the V–O system for the synthesis of VO ₂ and V ₂ O ₃ thin films. Journal of Materials Chemistry C, 2015, 3, 11357-11365.	2.7	55
61	Atomic layer deposition-enabled single layer of tungsten trioxide across a large area. Applied Materials Today, 2017, 6, 44-53.	2.3	52
62	<i>In Situ</i> Monitoring of Atomic Layer Deposition in Nanoporous Thin Films Using Ellipsometric Porosimetry. Langmuir, 2012, 28, 3852-3859.	1.6	51
63	ALD-grown seed layers for electrochemical copper deposition integrated with different diffusion barrier systems. Microelectronic Engineering, 2011, 88, 684-689.	1.1	50
64	The Influence of Ultrathin Amorphous ALD Alumina and Titania on the Rate Capability of Anatase TiO ₂ and LiMn ₂ O ₄ Lithium Ion Battery Electrodes. Advanced Materials Interfaces, 2017, 4, 1601237.	1.9	50
65	Ru thin film grown on TaN by plasma enhanced atomic layer deposition. Thin Solid Films, 2009, 517, 4689-4693.	0.8	49
66	Chemically Triggered Formation of Two-Dimensional Epitaxial Quantum Dot Superlattices. ACS Nano, 2016, 10, 6861-6870.	7.3	49
67	Atomic layer deposition-based synthesis of photoactive TiO2 nanoparticle chains by using carbon nanotubes as sacrificial templates. RSC Advances, 2014, 4, 11648.	1.7	48
68	Silver-polymer core-shell nanoparticles for ultrastable plasmon-enhanced photocatalysis. Applied Catalysis B: Environmental, 2017, 200, 31-38.	10.8	48
69	Catalyst-assisted chemical looping auto-thermal dry reforming: Spatial structuring effects on process efficiency. Applied Catalysis B: Environmental, 2018, 231, 123-136.	10.8	48
70	Atomic layer deposition of ZnO–SnO2 composite thin film: The influence of structure, composition and crystallinity on lithium-ion battery performance. Electrochimica Acta, 2019, 320, 134604.	2.6	48
71	Room-temperature grain growth in sputter-deposited Cu films. Applied Physics Letters, 2003, 82, 1863-1865.	1.5	47
72	Pt redistribution during Ni(Pt) silicide formation. Applied Physics Letters, 2008, 93, .	1.5	47

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73	Atomic layer deposition of vanadium oxides: process and application review. Materials Today Chemistry, 2019, 12, 396-423.	1.7	46
74	Air-based photoelectrochemical cell capturing water molecules from ambient air for hydrogen production. RSC Advances, 2014, 4, 29286-29290.	1.7	45
75	Molecular layer deposition of "titaniconeâ€, a titanium-based hybrid material, as an electrode for lithium-ion batteries. Dalton Transactions, 2016, 45, 1176-1184.	1.6	45
76	Ovonic Threshold‣witching Ge _{<i>x</i>} Se _{<i>y</i>} Chalcogenide Materials: Stoichiometry, Trap Nature, and Material Relaxation from First Principles. Physica Status Solidi - Rapid Research Letters, 2020, 14, 1900672.	1.2	45
77	CoSi2 formation in the Ti/Co/SiO2/Si system. Journal of Applied Physics, 2000, 88, 133-140.	1.1	44
78	Ultra-low-k cyclic carbon-bridged PMO films with a high chemical resistance. Journal of Materials Chemistry, 2012, 22, 8281.	6.7	44
79	Surface engineering of low enriched uranium–molybdenum. Journal of Nuclear Materials, 2013, 440, 220-228.	1.3	44
80	Atomic layer deposition-based tuning of the pore size in mesoporous thin films studied by in situ grazing incidence small angle X-ray scattering. Nanoscale, 2014, 6, 14991-14998.	2.8	44
81	Plasma-Enhanced Atomic Layer Deposition of Iron Phosphate as a Positive Electrode for 3D Lithium-Ion Microbatteries. Chemistry of Materials, 2016, 28, 3435-3445.	3.2	44
82	Atomic Layer Deposition Route To Tailor Nanoalloys of Noble and Non-noble Metals. ACS Nano, 2016, 10, 8770-8777.	7.3	44
83	Manganese oxide films with controlled oxidation state for water splitting devices through a combination of atomic layer deposition and post-deposition annealing. RSC Advances, 2016, 6, 98337-98343.	1.7	44
84	Plasma enhanced atomic layer deposition of Fe ₂ O ₃ thin films. Journal of Materials Chemistry A, 2014, 2, 10662-10667.	5.2	43
85	A rotary reactor for thermal and plasma-enhanced atomic layer deposition on powders and small objects. Surface and Coatings Technology, 2012, 213, 183-191.	2.2	42
86	Swelling of U(Mo) dispersion fuel under irradiation – Non-destructive analyses of the SELENIUM plates. Journal of Nuclear Materials, 2013, 442, 60-68.	1.3	42
87	Molecular layer deposition of "vanadiconeâ€, a vanadium-based hybrid material, as an electrode for lithium-ion batteries. Dalton Transactions, 2017, 46, 4542-4553.	1.6	42
88	Stabilizing Fluoride Phosphors: Surface Modification by Atomic Layer Deposition. Chemistry of Materials, 2019, 31, 7192-7202.	3.2	42
89	Epitaxial Formation of a Metastable Hexagonal Nickel–Silicide. Electrochemical and Solid-State Letters, 2008, 11, H266.	2.2	41
90	The effects of deposition temperature and ambient onÂtheÂphysicalÂand electrical performance ofÂDC-sputteredÂn-ZnO/p-Si heterojunction. Applied Physics A: Materials Science and Processing, 2010, 98, 357-365.	1.1	41

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91	Implementing TiO2 as gate dielectric for Ge-channel complementary metal-oxide-semiconductor devices by using HfO2/GeO2 interlayer. Applied Physics Letters, 2010, 97, .	1.5	41
92	Fuel swelling and interaction layer formation in the SELENIUM Si and ZrN coated U(Mo) dispersion fuel plates irradiated at high power in BR2. Journal of Nuclear Materials, 2015, 458, 380-393.	1.3	41
93	A core-shell structured Fe 2 O 3 /ZrO 2 @ZrO 2 nanomaterial with enhanced redox activity and stability for CO 2 conversion. Journal of CO2 Utilization, 2017, 17, 20-31.	3.3	41
94	Ultra-thin sub-10 nm Ga2O3-WO3 heterostructures developed by atomic layer deposition for sensitive and selective C2H5OH detection on ppm level. Sensors and Actuators B: Chemical, 2019, 287, 147-156.	4.0	41
95	Deposition of MnO Anode and MnO ₂ Cathode Thin Films by Plasma Enhanced Atomic Layer Deposition Using the Mn(thd) ₃ Precursor. Chemistry of Materials, 2015, 27, 3628-3635.	3.2	40
96	The transformation behaviour of "aluconesâ€; deposited by molecular layer deposition, in nanoporous Al ₂ O ₃ layers. Dalton Transactions, 2018, 47, 5860-5870.	1.6	40
97	The effect of silicon on the interaction between metallic uranium and aluminum: A 50 year long diffusion experiment. Journal of Nuclear Materials, 2008, 381, 242-248.	1.3	39
98	Aluminium atomic layer deposition applied to mesoporous zeolites for acid catalytic activity enhancement. Catalysis Science and Technology, 2011, 1, 218.	2.1	39
99	Influence of Ti on CoSi2 nucleation. Applied Physics Letters, 2000, 77, 3170-3172.	1.5	38
100	Solid-state formation of titanium carbide and molybdenum carbide as contacts for carbon-containing semiconductors. Journal of Applied Physics, 2006, 99, 063704.	1.1	38
101	Influence of a transient hexagonal phase on the microstructure and morphological stability of NiSi films. Applied Physics Letters, 2009, 94, .	1.5	38
102	Plasma-Enhanced ALD of Platinum with O ₂ , N ₂ and NH ₃ Plasmas. ECS Journal of Solid State Science and Technology, 2012, 1, Q123-Q129.	0.9	38
103	Influence of Carbon Alloying on the Thermal Stability and Resistive Switching Behavior of Copper-Telluride Based CBRAM Cells. ACS Applied Materials & Interfaces, 2013, 5, 6984-6989.	4.0	38
104	Atomic Layer Deposition of Pt Nanoparticles within the Cages of MIL-101: A Mild and Recyclable Hydrogenation Catalyst. Nanomaterials, 2016, 6, 45.	1.9	38
105	Acid–Base Mediated Ligand Exchange on Near-Infrared Absorbing, Indium-Based III–V Colloidal Quantum Dots. Journal of the American Chemical Society, 2021, 143, 4290-4301.	6.6	38
106	Atomic Layer Deposition of Aluminum Phosphate Based on the Plasma Polymerization of Trimethyl Phosphate. Chemistry of Materials, 2014, 26, 6863-6871.	3.2	37
107	Photocatalytic acetaldehyde oxidation in air using spacious TiO2 films prepared by atomic layer deposition on supported carbonaceous sacrificial templates. Applied Catalysis B: Environmental, 2014, 160-161, 204-210.	10.8	37
108	Low Temperature Atomic Layer Deposition of Crystalline In ₂ O ₃ Films. Journal of Physical Chemistry C, 2015, 119, 11786-11791.	1.5	37

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109	Bifunctional Co- and Ni- ferrites for catalyst-assisted chemical looping with alcohols. Applied Catalysis B: Environmental, 2018, 222, 59-72.	10.8	36
110	Nucleation Enhancement and Area-Selective Atomic Layer Deposition of Ruthenium Using RuO ₄ and H ₂ Gas. Chemistry of Materials, 2019, 31, 1491-1499.	3.2	36
111	The influence of Ti capping layers on CoSi2 formation. Microelectronic Engineering, 2000, 50, 125-132.	1.1	35
112	Atomic layer deposition of ruthenium at 100 °C using the RuO ₄ -precursor and H ₂ . Journal of Materials Chemistry C, 2015, 3, 132-137.	2.7	35
113	ALD assisted nanoplasmonic slot waveguide for on-chip enhanced Raman spectroscopy. APL Photonics, 2018, 3, .	3.0	35
114	CoSi2 formation in the presence of interfacial silicon oxide. Applied Physics Letters, 1999, 74, 2930-2932.	1.5	34
115	<i>In situ</i> synchrotron based x-ray techniques as monitoring tools for atomic layer deposition. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2014, 32, .	0.9	34
116	K ₂ MnF ₆ as a precursor for saturated red fluoride phosphors: the struggle for structural stability. Journal of Materials Chemistry C, 2017, 5, 10761-10769.	2.7	34
117	Plasmonic Near-Field Localization of Silver Core–Shell Nanoparticle Assemblies via Wet Chemistry Nanogap Engineering. ACS Applied Materials & Interfaces, 2017, 9, 41577-41585.	4.0	34
118	Electron Transfer and Near-Field Mechanisms in Plasmonic Gold-Nanoparticle-Modified TiO ₂ Photocatalytic Systems. ACS Applied Nano Materials, 2019, 2, 4067-4074.	2.4	34
119	In situ XAS and XRF study of nanoparticle nucleation during O3-based Pt deposition. Catalysis Today, 2014, 229, 2-13.	2.2	33
120	A Case Study of ALD Encapsulation of Quantum Dots: Embedding Supported CdSe/CdS/ZnS Quantum Dots in a ZnO Matrix. Journal of Physical Chemistry C, 2016, 120, 18039-18045.	1.5	33
121	Microwave induced "egg yolk―structure in Cr/V-MIL-53. Chemical Communications, 2017, 53, 8478-8481.	2.2	33
122	Thin film solid-state reactions forming carbides as contact materials for carbon-containing semiconductors. Journal of Applied Physics, 2007, 101, 053714.	1.1	32
123	Switching mechanism and reverse engineering of low-power Cu-based resistive switching devices. Nanoscale, 2013, 5, 11187.	2.8	32
124	Heterogeneous TiO ₂ /V ₂ O ₅ /Carbon Nanotube Electrodes for Lithium-Ion Batteries. ACS Applied Materials & Interfaces, 2017, 9, 8055-8064.	4.0	32
125	Plasma-enhanced atomic layer deposition of titanium phosphate as an electrode for lithium-ion batteries. Journal of Materials Chemistry A, 2017, 5, 330-338.	5.2	31
126	Formation and Functioning of Bimetallic Nanocatalysts: The Power of Xâ€ray Probes. Angewandte Chemie - International Edition, 2019, 58, 13220-13230.	7.2	31

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127	Colloidal III–V Quantum Dot Photodiodes for Shortâ€Wave Infrared Photodetection. Advanced Science, 2022, 9, e2200844.	5.6	31
128	Thermal and Plasma-Enhanced Atomic Layer Deposition of TiN Using TDMAT and NH ₃ on Particles Agitated in a Rotary Reactor. ACS Applied Materials & Interfaces, 2014, 6, 7316-7324.	4.0	30
129	Crystallization and semiconductor-metal switching behavior of thin VO2 layers grown by atomic layer deposition. Thin Solid Films, 2014, 550, 59-64.	0.8	30
130	Texture in thin film silicides and germanides: A review. Applied Physics Reviews, 2016, 3, 031302.	5.5	30
131	Reactive Diffusion in the Ni-Si System: Phase Sequence and Formation of Metal-Rich Phases. Defect and Diffusion Forum, 2005, 237-240, 825-836.	0.4	29
132	Influence of Ge substrate crystallinity on Co germanide formation in solid-state reactions. Applied Physics Letters, 2007, 90, 031906.	1.5	29
133	Embedding Quantum Dot Monolayers in Al ₂ O ₃ Using Atomic Layer Deposition. Chemistry of Materials, 2011, 23, 126-128.	3.2	29
134	Conformality of thermal and plasma enhanced atomic layer deposition on a non-woven fibrous substrate. Surface and Coatings Technology, 2012, 206, 4511-4517.	2.2	29
135	Factors Influencing the Conductivity of Aqueous Sol(ution)–Gel-Processed Al-Doped ZnO Films. Chemistry of Materials, 2014, 26, 5839-5851.	3.2	29
136	Formation of epitaxial CoSi2 by a Cr or Mo interlayer: Comparison with a Ti interlayer. Journal of Applied Physics, 2001, 89, 2146-2150.	1.1	28
137	In Situ IR Spectroscopic Investigation of Alumina ALD on Porous Silica Films: Thermal versus Plasma-Enhanced ALD. Journal of Physical Chemistry C, 2014, 118, 29854-29859.	1.5	28
138	Unravelling the Formation of Pt–Ga Alloyed Nanoparticles on Calcined Ga-Modified Hydrotalcites by <i>in Situ</i> XAS. Chemistry of Materials, 2014, 26, 5936-5949.	3.2	28
139	Direct Imaging of ALD Deposited Pt Nanoclusters inside the Giant Pores of MILâ€101. Particle and Particle Systems Characterization, 2016, 33, 382-387.	1.2	28
140	Effective reduction of fixed charge densities in germanium based metal-oxide-semiconductor devices. Applied Physics Letters, 2011, 99, .	1.5	27
141	Atomic layer deposited second-order nonlinear optical metamaterial for back-end integration with CMOS-compatible nanophotonic circuitry. Optics Letters, 2015, 40, 5371.	1.7	27
142	Atomic layer deposition of vanadium oxides for thin-film lithium-ion battery applications. RSC Advances, 2016, 6, 114658-114665.	1.7	27
143	CoSi2 formation through SiO2. Thin Solid Films, 2001, 386, 19-26.	0.8	26
144	Texture of tetragonalαâ^'FeSi2films on Si(001). Physical Review B, 2004, 69, .	1.1	26

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145	The influence of Pt redistribution on Ni1â^'xPtxSi growth properties. Journal of Applied Physics, 2010, 108, .	1.1	26
146	Anisotropic Atomic Layer Deposition Profiles of TiO ₂ in Hierarchical Silica Material with Multiple Porosity. Chemistry of Materials, 2012, 24, 2775-2780.	3.2	26
147	Scanning probe microscopy as a scalpel to probe filament formation in conductive bridging memory devices. Microelectronic Engineering, 2014, 120, 67-70.	1.1	26
148	<i>In Situ</i> Electron Paramagnetic Resonance and X-ray Diffraction Monitoring of Temperature-Induced Breathing and Related Structural Transformations in Activated V-Doped MIL-53(Al). Journal of Physical Chemistry C, 2016, 120, 17400-17407.	1.5	26
149	FeO controls the sintering of iron-based oxygen carriers in chemical looping CO2 conversion. Journal of CO2 Utilization, 2020, 40, 101216.	3.3	26
150	Ultrathin GeOxNy interlayer formed by <i>in situ</i> â€^NH3 plasma pretreatment for passivation of germanium metal-oxide-semiconductor devices. Applied Physics Letters, 2010, 97, .	1.5	25
151	Thermal-stability optimization of Al2O3/Cu–Te based conductive-bridging random access memory systems. Thin Solid Films, 2013, 533, 29-33.	0.8	25
152	Porous nanostructured metal oxides synthesized through atomic layer deposition on a carbonaceous template followed by calcination. Journal of Materials Chemistry A, 2015, 3, 2642-2649.	5.2	25
153	Key role of surface oxidation and reduction processes in the coarsening of Pt nanoparticles. Nanoscale, 2017, 9, 13159-13170.	2.8	25
154	Spacious and mechanically flexible mesoporous silica thin film composed of an open network of interlinked nanoslabs. Journal of Materials Chemistry, 2011, 21, 7692.	6.7	24
155	<i>In situ</i> synchrotron based x-ray fluorescence and scattering measurements during atomic layer deposition: Initial growth of HfO2 on Si and Ge substrates. Applied Physics Letters, 2011, 98, .	1.5	24
156	Catalytic activation of OKO zeolite with intersecting pores of 10- and 12-membered rings using atomic layer deposition of aluminium. Chemical Communications, 2014, 50, 4610-4612.	2.2	24
157	Combinatorial Study of Ag–Te Thin Films and Their Application as Cation Supply Layer in CBRAM Cells. ACS Combinatorial Science, 2015, 17, 334-340.	3.8	24
158	Monte Carlo simulations of atomic layer deposition on 3D large surface area structures: Required precursor exposure for pillar- versus hole-type structures. Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2017, 35, .	0.9	24
159	Sensing the framework state and guest molecules in MIL-53(Al) via the electron paramagnetic resonance spectrum of V ^{IV} dopant ions. Physical Chemistry Chemical Physics, 2017, 19, 24545-24554.	1.3	24
160	Ligand Binding to Copper Nanocrystals: Amines and Carboxylic Acids and the Role of Surface Oxides. Chemistry of Materials, 2019, 31, 2058-2067.	3.2	24
161	Bifunctional earth-abundant phosphate/phosphide catalysts prepared <i>via</i> atomic layer deposition for electrocatalytic water splitting. Nanoscale Advances, 2019, 1, 4166-4172.	2.2	24
162	Annealing effect on the metal gate effective work function modulation for the Al/TiN/SiO2/p-Si structure. Microelectronic Engineering, 2011, 88, 573-577.	1.1	23

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CHRISTOPHE DETAVERNIER

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CHRISTOPHE DETAVERNIER

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